Atty Docket No.:

FORM PTO-1595 06-04



04-10-2006

U.S. DEPARTMENT OF COMMERCE Patent and Trademark Office

To the Director of the United States Patent and Trademan	1936 in the attached original documents or copy thereof.	
1. Name of conveying party(ies):	2. Name and address of receiving party(ies):	
Toshiya HAMADA Yasushi FUJINAMI Tatsuya KAKUMU Koji IHARA Shusuke UTSUMI Akihiko UEDA Additional name(s) of conveying party(ies) attached? ☐ Yes ■ No	Name: 1) SONY CORPORATION 2) SONY COMPUTER ENTERTANIMENT INC. Address: 1) 6-7-35 Kitashinagawa, Shinagawa-ku, Tokyo, 141-0001 Japan 2) 2-6-21, Minami-aoyama, Minato-ku, Tokyo, Japan	
3. Nature of Conveyance:	Additional name(s) and address(es) attached? □ Yes ■ No	
4. Application number(s) or patent number(s):		
☐ This document is being filed together with a new application		
A. Patent Application No.(s) 11/289,272	B. Patent No.(s)	
Additional numbers attached	.ed? □ Yes ■ No	
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total applications and patents involved: 1	
Customer Number 22850 Tel. (703) 413-3000 Fax. (703) 413-2220	7. Total fee (37 CFR 3.41): \$40.00 ■ Enclosed □ Authorized to be charged to deposit account 8. Deposit account number: 15-0030 (Attach duplicate copy of this page if paying by deposit account)	
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9. Statement and signature To the best of my knowledge and belief, the foregoing information copy of the original document. Bradley D. Lytle Name of Person Signing Signa Joseph Scat Registration Number: 40,073 Registration N Total number of pages including	APR 0 4 2006 Date fetta, Jr. lo. 26,803	
Do not detach the Mail documents to be recorded with required cover sheet information. Director of the United States Pa	ito: 64795/3028/82895/1/386688988/1/889878	

Mail Stop Assignment Recordation Services Alexandria, Virginia. 22313

Docket Number: 279699US6X

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name are listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

REPRODUCTION APPARATUS, REPRODUCTION METHOD, REPRODUCTION PROGRAM, RECORD

MEDIUM, AND DATA STRUCTURE

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 6-7-35 Kitashinagawa, Shinagawa-ku, Tokyo, 141-0001 Japan and Sony Computer Entertainment Inc. with offices at 2-6-21, Minamiaoyama, Minato-ku, Tokyo, Japan (hereinafter referenced as ASSIGNEES) are desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEES, their successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEES, as the assignees of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEES or their designee, as ASSIGNEES or their successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEES thereof shall hereafter require and prepare at their own expense;

And I further agree that ASSIGNEES will, upon their request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 11/289, 272 Filing Date: November 30, 2005

This assignment executed on the dates indicated below.

Toshiya HAMADA	
Name of first or sole inventor	Execution date of U.S. Patent Application
Saitama, Japan	
Residence of first or sole inventor	
Signature of first or sole inventor	Date of this assignment
Signature of first or sole inventor	Date of this assignment

PATENT REEL: 017750 FRAME: 0417

Yasushi FUJINAMI	
Name of second inventor	Execution date of U.S. Patent Application
Tokyo, Japan	
Residence of second inventor	
Signature of second inventor	March (. 2006 Date of this assignment
Signature of second inventor	Date of this assignment
Tatsuya KAKUMU	
Name of third inventor	Execution date of U.S. Patent Application
Tokyo, Japan	
Residence of third inventor	
Signature of third inventor	March 7, 2006 Date of this assignment
Signature of third inventor	Date of this assignment
Koji IHARA	
Name of fourth inventor	Execution date of U.S. Patent Application
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Noji Signature of fourth inventor	March 3, 2006 Date of this assignment
Signature of fourth inventor	Date of this assignment
Shusuke UTSUMI	
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Shusuke Utsumi Signature of fifth inventor	March 7, 2006 Date of this assignment
Signature of fifth inventor	Date of this assignment
Akihiko UEDA	
Name of sixth inventor	Execution date of U.S. Patent Application
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Residence of sixth inventor	
Akihiko Yeda	March. 3. 2006
Signature of sixth inventor	Date of this assignment

PATENT REEL: 017750 FRAME: 0418

RECORDED: 04/04/2006